



DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Method of Forming Wiring in Semiconductor Devices the specification of which (check one): ☐ is attached hereto; ☒ was filed on December 28, 2001 as Application Serial No. 10/032,687 and was amended on _____ (if applicable); ☐ was filed as PCT International Application No. _____ on _____ and was amended under Article 19 on _____ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56.

I hereby claim foreign priority benefits under 35 U.S.C. §119 of any foreign application(s) for patent or inventor's certificate or of any PCT international application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed:

| | | |
|-----------------------------|--------------------------|------------------------|
| <u>2001-75440</u> | <u>Republic of Korea</u> | <u>30/11/2001</u> |
| (Application Serial Number) | (Country) | (Day/Month/Year Filed) |
| <hr/> | | |
| _____ | _____ | _____ |
| (Application Serial Number) | (Country) | (Day/Month/Year Filed) |

Priority Claimed

| | |
|-------------------------------------|--------------------------|
| <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| Yes | No |

| | |
|--------------------------|--------------------------|
| <input type="checkbox"/> | <input type="checkbox"/> |
| Yes | No |

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below:

| | |
|-----------------------------|------------------------|
| _____ | _____ |
| (Application Serial Number) | (Day/Month/Year Filed) |
| <hr/> | |
| _____ | _____ |
| (Application Serial Number) | (Day/Month/Year Filed) |

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56 which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application:

| | | |
|-----------------------------|------------------------|---|
| _____ | _____ | _____ |
| (Application Serial Number) | (Day/Month/Year Filed) | (Status-Patented, Pending or Abandoned) |
| <hr/> | | |
| _____ | _____ | _____ |
| (Application Serial Number) | (Day/Month/Year Filed) | (Status-Patented, Pending or Abandoned) |

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Alvin D. Shulman (19,412)
 Allen H. Gerstein (22,218)
 Nate F. Scarpelli (22,320)
 Edward M. O'Toole (22,477)
 Michael F. Borun (25,447)
 Trevor B. Joike (25,542)
 Carl E. Moore, Jr. (26,487)

Richard H. Anderson (26,526)
 Patrick D. Ertel (26,877)
 James P. Zeller (28,491)
 William E. McCracken (30,195)
 Richard A. Schnurr (30,890)
 Anthony Nimmo (30,920)
 Christine A. Dudzik (31,245)

Kevin D. Hogg (31,839)
 Jeffrey S. Sharp (31,879)
 Martin J. Hirsch (32,237)
 James J. Napoli (32,361)
 Richard M. La Barge (32,254)
 Li-Hsien Rin-Laures, M.D.
 (33,547)
 Douglass C. Hochstetler (33,710)

Robert M. Gerstein (34,824)
 David W. Clough (36,107)
 James A. Flight (37,622)
 Roger A. Heppermann (37,641)
 David A. Gass (38,153)
 Gregory C. Mayer (38,238)

Send correspondence to: James A. Flight

| FIRM NAME | PHONE NO. | STREET | CITY & STATE | ZIP CODE |
|--------------------------------|--------------|--|-------------------|------------|
| Marshall, Gerstein, & Borun | 312-474-6300 | 6300 Sears Tower 233 South Wacker Drive | Chicago, Illinois | 60606-6402 |

| | |
|--|---|
| Full Name of First or Sole Inventor KIM, Hyung Kyun | Citizenship Republic of Korea |
| Residence Address Street Kyungki-Do, Republic of Korea | Post Office Address Street Godamgisuksa 102-1205, Godam-Dong, Bubal-Uep, Ichon-Shi, Kyungki-Do, Republic of Korea |
| City (Zip) | City (Zip) |
| State or Country Republic of Korea | State or Country Republic of Korea |
| Date <input checked="" type="checkbox"/> February 18, 2002 | Signature <input checked="" type="checkbox"/> <i>Kim Hyung Kyun</i> |

| | |
|---|---|
| Second Joint Inventor, if any LEE, Min Yong | Citizenship Republic of Korea |
| Residence Address Street Seoul, Republic of Korea | Post Office Address Street 115-7, Samjeon-Dong, Songpa-Gu, Seoul, Republic of Korea |
| City (Zip) | City (Zip) |
| State or Country Republic of Korea | State or Country Republic of Korea |
| Date <input checked="" type="checkbox"/> February 18, 2002 | Signature <input checked="" type="checkbox"/> <i>Lee Min Yong</i> |

| | |
|--|---|
| Third Joint Inventor, if any SON, Kwon | Citizenship Republic of Korea |
| Residence Address - Street Kyungki-Do, Republic of Korea | Post Office Address Street Gunyang Apt. 201-1604, Daeyami-Dong, Goonpo-Shi, Kyungki-Do, Republic of Korea |
| City (Zip) | City (Zip) |
| State or Country Republic of Korea | State or Country Republic of Korea |
| Date <input checked="" type="checkbox"/> February 18, 2002 | Signature <input checked="" type="checkbox"/> <i>Son Kwon</i> |